Dense nanoimprinted silicon nanowire arrays with passivated axial \textit{p-i-n} junctions for photovoltaic applications

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We report on the fabrication and photovoltaic characteristics of vertical arrays of silicon axial \textit{p-i-n} junction nanowire (NW) solar cells grown by vapor-liquid-solid (VLS) epitaxy. NW surface passivation with silicon dioxide shell is shown to enhance carrier recombination time, open-circuit voltage ($V_{OC}$), short-circuit current density ($J_{SC}$), and fill factor (FF). The photovoltaic performance of passivated individual NW and NW arrays was compared under 532 nm laser illumination with power density of ~10 W/cm². Higher values of $V_{OC}$ and FF in the NW arrays are explained by enhanced light trapping. In order to verify the effect of NW density on light absorption and hence on the photovoltaic performance of NW arrays, dense Si NW arrays were fabricated using nanoimprint lithography to periodically arrange the gold seed particles prior to epitaxial growth. Compared to sparse NW arrays fabricated using VLS growth from randomly distributed gold seeds, the nanoimprinted NW array solar cells show a greatly increased peak external quantum efficiency of ~8% and internal quantum efficiency of ~90% in the visible spectral range. Three-dimensional finite-difference time-domain simulations of Si NW periodic arrays with varying pitch (P) confirm the importance of high NW density. Specifically, due to diffractive scattering and light trapping, absorption efficiency close to 100% in the 400–650 nm spectral range is calculated for a Si NW array with P = 250 nm, significantly outperforming a blanket Si film of the same thickness. © 2015 AIP Publishing LLC. [http://dx.doi.org/10.1063/1.4916535]

Metal-catalyzed vapor-liquid-solid (VLS) growth of Si/Ge axial \textit{p-i-n} junction nanowires (NWs) is of interest because of their potential application for large-area, broadband, high-efficiency solar cells. It has recently been demonstrated that it is possible to grow Si/Ge axial heterojunction NWs with abrupt interfaces, as well as to control both Si and Ge composition and doping profiles. This opens up new possibilities for solar cell devices. A promising possible structure is an array of hetero-NWs with separate \textit{p-i-n} Ge and Si sections connected by a low-resistance \textit{np} tunneling contact, leading to a solar cell with broader absorption, higher open-circuit voltage ($V_{OC}$), and higher overall efficiency compared to an all-Si NW solar cell. Investigation of such devices is still in its infancy. Before realizing this promising hetero-NW device, we focus here on the characterization of solar cells made from axial \textit{p-i-n} Si NWs with diameters ~100–200 nm.

Recent studies on Si NW solar cells were mostly focused on radial \textit{p-n} or \textit{p-i-n} junctions with relatively large wire diameters, between 1 and 20 μm, and array pitch (P) between 1 and 30 μm. For example, in 2012, Gharghi \textit{et al.} reported a hetero-junction Si micro-wire solar cell with core/shell geometry and $V_{OC}$ of 0.591 V, short-circuit current density ($J_{SC}$) of 31.1 mA/cm² and power conversion efficiency (PCE) of 12.2%. In 2013, Yoo \textit{et al.} demonstrated epitaxial growth of radial Si \textit{p-i-n} junction solar cell with very high $J_{SC}$ of 40 mA/cm² and 10.8% PCE despite a relatively low $V_{OC}$ of 0.4 V. One of the main reasons that a radial geometry is preferred is that, in such a structure, the carrier separation takes place in the radial direction, so the carrier collection distance is smaller or comparable to the minority carrier diffusion length, resulting in a higher carrier collection efficiency. On the other hand, Si NW solar cells based on \textit{p-i-n} junctions have received less attention. While there have been recent reports of axial NW cells based on InP (Ref. 17) and GaAs, the most recent paper on axial Si \textit{p-i-n} junction dates back to 2009, where Tian \textit{et al.} reported a single Si NW solar cell with $V_{OC}$ = 0.29 V, short-circuit current $I_{SC}$ = 31.1 μA, and PCE of 0.5% in a ~300 nm diameter NW.

In this paper, we focus on truly sub-micrometer Si axial \textit{p-i-n} junction NWs with diameter <200 nm. The axial geometry and smaller diameter are chosen in view of future realization of Si/Ge hetero-NWs, where the lattice mismatch strain can be alleviated by lateral sidewall expansion, which is impossible in a radial geometry. Moreover, unlike the radial geometry, an axial geometry allows the introduction of a long intrinsic section between the junctions, which effectively reduces the leakage current, thus improving the ideality factor. Both sparse random NW arrays and dense square arrays with pitch P = 500 nm were studied, with the latter chosen based on a 3D finite-difference time-domain (FDTD) simulation of the optical properties for NW arrays of varying P, where it was found that a square periodic NW...
array of sub-0.5 μm pitch—within reach of nanoimprint lithography (NIL)—would outperform a blanket Si p-i-n junction of the same thickness. The small P also allows us to achieve relatively large active area.

In all of our structures, vertical arrays of Si NWs were grown at 900 °C from SiCl4/H2/N2 mixture using 100 nm Au nanoparticles randomly dispersed on 350 μm thick p+-Si (111) substrates with doping of \( \sim 10^{19} \text{ cm}^{-3} \). We utilized BCl3 (2% in N2) and PH3 (100 ppm in N2) as the p- and n-type dopants, respectively, with B (P)/Si ratio in the gas phase of \( 3 \times 10^{-3} \) (1.3 \( \times 10^{-5} \)). In our sparse random NW arrays, the axial p-i-n junctions were formed by the sequential growth of 4 μm long B-doped, nominally undoped, and P-doped sections of NWs, for a total length \( L \sim 12 \mu \text{m} \). The total NW growth time was 6 min, with 2 min for each section. We did not observe any significant variations in the growth rate of Si NWs due to the dopants, which is presumably caused by low BCl3 and PH3 partial pressures as well as by the high growth rate of undoped Si NWs \((\approx 2.0 \pm 0.1 \mu \text{m/min})\). The dopant densities of the p- and n-sections have a lower bound of \( \sim 6 \times 10^{17} \text{ cm}^{-3} \) from the two-point resistance measurements of individual NWs (assuming perfect contacts, the actual doping density is \( >10^{18} \text{ cm}^{-3} \) as estimated by STEM EELS analysis—not shown here), as well as from other Si NWs grown under the same conditions.

Figure 1(a) shows a tilted scanning electron microscope (SEM) image of a vertically aligned Si NW array. Different contrast in the SEM image taken at a higher magnification in Fig. 1(b) corresponds to the doping profile along the NW axis with the p-doped section being the brightest one. The diffusion lengths of the dopants are less than 20 nm, taking the dopant diffusion coefficients on the order of \( 10^{-14} \text{cm}^2/\text{s} \), and hence negligible compared to the length of intrinsic section. In an attempt to obtain a sharper doping profile, a 30 s growth interruption was adopted while switching the doping gases during which the hydrogen flow was reduced, so the growth rate of Si NWs was close to zero. Figure 1(c) shows the transition between p-doped and undoped segments, which is marked by a small bulge caused by the growth interruption. In these arrays, the average NW density was relatively low, on the order of \( \sim 0.1-0.2 \mu \text{m}^{-2} \), as determined from top-view SEM images, resulting from the low Au nanoparticle surface density. The density can be enhanced significantly by turning to NIL, as will be discussed later.

After growth, passivation of Si NW surface was achieved by rapid thermal oxidation at 1000 °C for 1 min to form a SiO2 sheath of \( \sim 12 \text{ nm} \) thickness. Inset in Fig. 1(a) shows a transmission electron microscopy (TEM) image of an oxidized Si NW. The NW arrays were planarized using SU-8 photosist, followed by reactive ion etching (RIE) with CF3:O2 = 4:1 (Ref. 25) to expose the NW tips. Top contact electrodes to the n-doped NWs were made by sputter deposition of a 200 nm indium-zinc-oxide (IZO) layer that is transparent in the visible spectral range. The p-contact was made by backside metallization of the p+-Si substrate with Ag paste. The number of NWs contacted together in the 2.5 mm diameter top electrode area of the unpassivated array (density \( \approx 0.18 \mu \text{m}^{-2} \)) was about \( 9 \times 10^5 \); for the passivated array (density \( \approx 0.09 \mu \text{m}^{-2} \)) with 0.8 × 0.8 mm2 top electrode area, the corresponding number was about \( 6 \times 10^4 \), as estimated from top-view SEM micrographs.

Figure 2 shows the photovoltaic (PV) performance of both unpassivated and passivated Si NW arrays in dark and under AM 1.5 global (G) illumination. Clear rectification behavior and power generation were observed in both arrays. The unpassivated Si NW arrays in Fig. 2(a) exhibited an open circuit voltage \( V_{OC} = 170 \text{mV} \), a short circuit current density \( J_{SC} > 10.5 \mu \text{A/cm}^2 \) (with some uncertainty due to the unknown fraction of properly contacted NWs), and a fill factor FF = 30%.

It is evident from the I-V curve that the unpassivated array in Fig. 2(a) has a relatively high series resistance and low shunt resistance. In the NW arrays passivated by rapid thermal oxidation, the performance is improved, with \( V_{OC} \) and FF increasing to 250 mV and 36%, respectively. The seemingly lower \( J_{SC} \) in the passivated NW array of Fig. 2(b) is due to a lower NW density. A more proper comparison of the current density calculated by considering the cross-sectional area of the Si NWs only, rather than the total electrode area, would give \( J_{NW} > 3.7 \mu \text{A/cm}^2 \) for unpassivated array and \( J_{NW} > 6.5 \mu \text{A/cm}^2 \) for the passivated one. The clear improvements in \( V_{OC} \) and \( J_{SC} \) are consistent with the expected reduction in the surface recombination rate. It should be pointed out that the NWs
in the passivated array had a slightly smaller diameter due to the consumption of Si during thermal oxidation (see inset of Fig. 1), implying better PV performance even with smaller light-absorbing Si volume.

As a proof of the improved surface conditions of the passivated samples, we measured the response time of both passivated and unpassivated samples. For the measurement set up, the samples were illuminated by a 640 nm laser beam with a square wave output. The samples were not biased by external sources and were connected to a 4.5 kΩ resistor load. We monitor the photocurrent generated in the device through the resistor using an oscilloscope. Figure 3 shows the results (for clarity, the signals are normalized). The exponential fitting coefficients for the unpassivated and passivated samples are 0.36 μs and 0.55 μs, respectively. The passivated sample shows a ~50% longer response time. For comparison, we also measured the response time of a high-efficiency reference single-crystalline Si solar cell, which exhibits a much longer response time, due to optimized passivation, see Fig. 3.

Compared to planar devices, NW solar cell devices are expected to exhibit improved optical characteristics. We have performed reflectivity measurements using an integrating sphere coupled to the external quantum efficiency (EQE) measurement system (QEX10, PV Measurements, Inc.) where a calibration sample was used as the reflectance standard (Fluorilon FWS-99-10c, Avian Technologies). The measured reflectance spectra are shown in Fig. 4. We observed a total reflectance (including specular and diffuse components) of ~20% over the 400–1100 nm spectral range, which is significantly lower than that of a planar device with no anti-reflection coating, implying less reflectance loss and more light trapping. The fact that the overall reflectance of the passivated sample is slightly higher than the unpassivated one is due to lower NW density (0.09 μm² as compared to 0.18 μm² for the unpassivated sample). It is interesting to note that the measured specular reflectance of the planarized NW array was ~6% (dotted green line in Fig. 4), indicating strong light scattering by the NWs.

To further prove that the NW devices can benefit from the array structure leading to enhanced absorbance, the PV performance of individual NWs and NW arrays passivated under the same conditions was compared using a 532 nm laser with a power density of 10 W/cm² (a laser was used...
here because the AM 1.5G response of the individual NW was too weak to be measured). Note that an individual horizontally aligned NW cannot be directly compared to a vertical NW array, since the active region of the individual NW is exposed to the full optical field of the laser, whereas in a vertical NW array, there is optical loss in the n-contact regions above the active regions of the NWs (especially at shorter wavelengths). Nonetheless, the NW array sample exhibits improved $V_{OC}$ and FF compared to the individual NW (Fig. 5), which can be assigned to enhanced light trapping in the NW arrays. It should be also noted that compared with the NW array devices, we have introduced more series resistance for the single NW device by making an extra metal (Ni) contact to the $p$-Si (inset in Fig. 5(a)), however contact series resistance should have no impact on $V_{OC}$.

While the passivated sample showed improved $V_{OC}$, $J_{SC}$, and FF, the EQE is low (<1%) for both unpassivated and passivated samples (Fig. 6(a)). The best way to understand this is to carry out the optical FDTD simulations. There have been numerous reports on optimizing absorption of nanowire arrays. However, their conclusions vary since the absorption is driven by numerous competing factors and most of the studies focus on different parameters, such as radii, length, and pitch. Here, we study the effect of NW pitch and length on the absorption while keeping the NW diameter constant (consistent with our VLS growth). Figure 6(b) reports the simulated optical absorption as extracted from a full 3D FDTD simulation, for $n$-$i$-$p$ NW arrays with $P$ ranging from 0.25 $\mu$m to 3 $\mu$m and considering an active region comprising the intrinsic 4 $\mu$m section and estimated 1 $\mu$m minority carrier diffusion lengths in both $p$- and $n$-type doped sections (see insets in Fig. 6(b) for the simulation geometry, including the blanket Si film of the same doping profile is plotted for comparison). The absorption spectrum of a 12 $\mu$m thick Si film with the same doping profile is plotted for comparison, see inset for simulation geometry.

**FIG. 5.** Comparison under 532 nm laser illumination of a single Si NW (a) with $V_{OC} = 0.49$ V, FF = 28.3% and a passivated Si NW array (b) with $V_{OC} = 0.58$ V, FF = 39.3%. Insets show the four-point $I$-$V$ measurement geometry of the single NW (a) and a top view SEM of the planarized array with the protruding NW tips clearly visible (b).

**FIG. 6.** (a) EQE of both passivated and unpassivated NW arrays; (b) FDTD simulated absorption spectra of the active region in square NW arrays (12 $\mu$m long NWs of 140 nm diameter and 4 $\mu$m intrinsic section) as a function of $P$. The absorption spectrum of a 12 $\mu$m thick Si film with the same doping profile is plotted for comparison, see inset for simulation geometry.
flow at different heights along the NW array axis, so that absorption for different sections of the NW array could be calculated from the difference of the power flow between corresponding monitors. During the simulation, non-uniform mesh was used with roughly 15 mesh points per wavelength (in the medium), which balanced accuracy and computational cost. In order to minimize the simulation volume and runtime, the NW arrays were assumed to be uniform and distributed according to a square lattice, so that periodic boundary conditions could be imposed on the remaining lateral dimensions. Also, the NWs were embedded in 10 μm thick SU-8 photore sist, with index of refraction taken from Ref. 35. For the NWs, we used the Si refractive index as reported by Palik. 36

As can be seen in Fig. 6(b), in a sparse array with period P = 3 μm, which is close to the average inter-wire distance in our random NW arrays, a strong absorption peak can be observed at shorter wavelengths near λ = 450 nm. The absorption peak becomes stronger at P = 1 μm, and then weakens and merges into the absorption spectrum for denser arrays (P ≥ 0.5 μm). By comparison, due to the large absorption coefficient of Si at shorter wavelengths (e.g., α = 2.55 × 10^4 cm^-1 at 450 nm, corresponding to a propagation length of 390 nm), a blanket Si film with same total thickness of 12 μm (and same substrate) shows no significant absorption in the 6-μm-thick middle active region for λ < 550 nm, since most of the incident light is absorbed in the top region. Thus, the NW arrays perform better since diffractive scattering from each sub-micron diameter NW allows for a significant fraction of the incident electromagnetic fields to be directed off-normal and reach the active regions of neighboring NWs.

In order to experimentally verify our simulation results, dense Si NW square arrays with P = 0.5 μm were fabricated using NIL technique to arrange the gold seed particles. MR-I 7020E resist was first spun on a heavily p-doped Si (111) substrate. A mold with an array of 150-nm-diameter pillars and P = 500 nm was then pressed into the resist, followed by RIE to remove the residue and expose the Si substrate. Thereafter, 30 nm of Au was evaporated on the substrate and the polymer was lifted-off in acetone (see Fig. 7(a)), leaving behind a periodic array of gold nanodots. Figure 7(b) shows the resulting square array of gold seed particles. The NWs growth, SiO2-passivation, and device fabrication were identical to the random Si NW arrays reported above. The resulting p-i-n NW segments were 1.7 μm, 3.5 μm, 1.7 μm (sample A, total NW length L ≈ 7 μm) and 2.2 μm, 5 μm, and 1.6 μm (sample B, L ≈ 8.8 μm). The NW diameter was ≈170 nm for both samples. The slightly larger NW diameter is due to larger gold seed particles formed by NIL. Figure 7(c) shows a top view of sample A. It can be seen that some NWs are missing or merged during the growth, resulting in a lower final NW density (~2 μm^{-2} for both samples) than the nanoimprint maximum (4 μm^{-2}). Figure 7(d) shows a 52°-tilted view of a NW array after IZO top contact deposition, with contacted NWs poking through the IZO.

The photovoltaic characterization of samples A and B is reported in Figs. 8 and 9. It is evident from Fig. 9(a) that the EQE increased by more than one order of magnitude to peak values of about 3% at 500 nm (Sample A) and 8% at 570 nm (Sample B). Sample B exhibited better performance than sample A as a result of higher absorption due to longer NWs, indicating the possibility of a further improvement by using even longer NWs (as discussed later). The corresponding FDTD-simulated absorption spectra are shown in Fig. 9(b), where the simulation geometry consisting of a square array of NWs with an active region comprising the intrinsic sections plus 1 μm excursions into the p- and n-type doped sections, as shown in the insets of Fig. 9(b). We can further extract the internal quantum efficiency (IQE) from the EQE spectra by dividing the experimentally measured EQE by the
simulated absorption. The result, shown in Fig. 9(c), gives a peak IQE of ~50% (sample A) and 90% (sample B) in the visible range for our dense nanoimprinted NW arrays.

It should be noted that the absorption calculated in Fig. 9(b) is relatively low, due to the relatively short NWs used in the NIL-produced array growth (total NW length $L \sim 7 \mu m$ and 8.8 $\mu m$ for samples A and B, respectively). The absorption can be further enhanced by using longer NWs with longer intrinsic sections and shorter doped electrodes.

Several features of our NW arrays still require optimization to improve the PV performance. First, while the passivation step helped increase the recombination time, $V_{OC}$ and $J_{SC}$ are still rather low. One possible reason would be the NWs are still suffering from the high surface recombination velocity (SRV), since the axial structure of our device is very sensitive to SRV due to the exposed depletion region at the surface.\(^{37}\) Another possibility that would lead to a low $J_{SC}$ is that not all the nanowires were properly contacted. In fact, the green dashed line in Fig. 8 shows a 15% improvement on $J_{SC}$ after a second deposition of IZO top contact with the sample tilted at a small angle with respect to the IZO source, ensuring a higher fraction of contacted NWs. Second, since carrier separation is most efficient within the depletion region,\(^{38}\) the $p$- and $n$-sections of the NWs should be made shorter and the $i$-Si section should be made longer to improve the carrier collection efficiency. To verify this, we repeated the 3D FDTD simulations for arrays of NWs with the same total length $L \sim 12 \mu m$ as in Fig. 6(b) but with much shorter doped electrodes (see inset in Fig. 10 for the new NW geometry). As can be seen in Fig. 10, the absorption, integrated over the entire 12 $\mu m$ length, is low when $P \geq 2 \mu m$, with the overall absorption of the NW arrays lower than that of a blanket Si film. The physical reason for this result is that most of the incident light propagates and is absorbed directly in the silicon substrate, thus explaining the low experimental reflectance, as shown in Fig. 4, and low EQE. Moreover, the diffracted propagating modes generated by the presence of NWs increase the transmission into the Si substrate, further reducing the reflectance and optical absorption in the NW array.\(^{31}\) However, as the density of the NWs increases, the simulated absorption of the NW arrays does as well, exceeding the absorption of a blanket Si film when $P \leq 0.5 \mu m$ and also improving on the previous structure with 4 $\mu m$ long $p$-, $n$- and $i$-sections. Finally, increasing the NW density by reducing $P$ well below 0.5 $\mu m$ can further improve the performance. For example, according to our simulations in Fig. 10, the absorption reaches nearly unity for $\lambda < 700$ nm when $P = 0.25 \mu m$. A cell with improved performance will also have to rely on uniformly contacted NWs to increase the carrier extraction efficiency over the entire area.

In summary, we have demonstrated solar cells based on Si axial $p$-$i$-$n$ junction NW arrays with diameter $< 200$ nm. We have studied the PV performance of both unpassivated and SiO$_2$-passivated samples under AM 1.5 G illumination. The improvements on recombination time, $V_{OC}$, $J_{SC}$, and FF for passivated samples were explained by reduced surface recombination. The enhanced optical characteristics of our NW arrays devices were confirmed by reflectance measurements, as well as the comparison of PV performance of
passivated Si NW arrays and single NW devices. Dense Si NW arrays were fabricated using NIL. Improved EQE of ~3% and 8% and peak IQE of ~50% and 90% in the visible spectral range were obtained for samples with different NW lengths, due to improved absorption, according to FDTD simulations of absorption in Si NW arrays with varying pitch. We believe that the performance of our NW solar cells could be further improved by optimizing the geometry of the NW and by increasing the NW density. The study of Si axial p-i-n junction NW solar cells provides a promising alternative for PV applications of Si and sheds light on the realization of high performance NW tandem solar cells.

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28. Certain commercial equipment instruments or materials are identified in this paper to foster understanding. Such identification does not imply recommendation or endorsement by the National Institute of Standards and Technology nor does it imply that the materials or equipment identified are necessarily the best available for the purpose.
32. See www.microchem.com/RequestInformation.htm for data sheet for the refractive index of SU-8.